

## **Agenda: Advanced Seminars**

Day 1 | Tuesday, April 29, 2025

Register or learn more here

8:30 AM	Registration, Coffee & Breakfast							
9:00 AM		Morning Sessions						
12:15 PM		Lunch						
1:15 PM		Afternoon Sessions						
Room	Topic	Sessions & Descriptions (Please note: Agendas are subject to change)						
GOLD 9:00-4:30	Structures	<ul> <li>Session 1: Solving Nonlinear Finite Element Models in Abaqus</li> <li>Session 2: Advantages of Preprocessing &amp; Postprocessing in 3DEXPERIENCE</li> <li>Session 2: Material Calibration for Abaqus</li> <li>Session 5: Abaqus and the Migration to Python3</li> <li>Session 3: A New Constitutive Material Model for Paperboard &amp; Cardboard Packaging Simulations</li> </ul>						
COPPER 9:00-5:30	Electromagnetics	<ul> <li>Session 1 &amp; 2: SIMULIA Partner Strategy Sessions</li> <li>Session 3: Presentation 1: Keep Cool! Electronics Cooling Simulation Using CST Studio Suite</li></ul>						
BRONZE 9:00-4:30	Multibody System Dynamics / Motion	• Session 1: Multibody and Motion State of Technology & Motion Vertical Roles on the 3DEXPERIENCE Platform • Session 2: Simpack Automotive Wizard Database & Realtime Technology Application • Session 4: Introducing Simpack Component for Isight						
SILVER 9:00-4:30	Automation & Optimization	Agenda to include: What's New in Automation & Democratization; Industry Highlight: Virtual Twin Real-Time Fault Diagnosis and Predictive Maintenance for Aircraft – Boeing; What's New in Design Exploration; Use Case: Combining Parametric and Non-Parametric Design Exploration to Brake Squeal; Design Exploration in Practice – Optimec; Managing Virtual Test Plans with the New Test Manager Role; Industry Highlight: Requirements Cascading and CAE Test Management for a Vehicle BIW						
GRANITE 9:00-2:45	Fluids	<ul> <li>Session 1: Optimizing Electric Cargo Scooter Design: Aerodynamics and Manufacturability Through MODSIM</li> <li>Session 2: 3DEXPERIENCE Platform CFD (FMK) New Release Features Demonstration</li> <li>Session 3: Accelerate Aerodynamics &amp; Aeroacoustics with PowerFLOW on GPU</li> <li>Session 5: Virtual Porous Media Lab Solution</li> </ul>						
PEARL 9:00-12:15	Fatigue	Deep Dive on TCD (Theory of Critical Distance): fe-safe provides various fatigue analysis methods, algorithms, and built-in material properties. We have introduced these different methods an algorithms in detail for many years. In 2024, we compared the characteristics and performances of all strain-based and stress-based algorithms implemented in fe-safe by comparing the results for the same problem. TCD (Theory of Critical Distance) and DTMF (Thermo-Mechanical Fatigue) were also introduced.  This year, we will introduce TCD methods and algorithms available in fe-safe, mesh correlation, and TCD Best Practices through TCD Deep Dive. With this, we expect that users will be able to apply more sophisticated and practical fatigue life prediction to a component design by judging whether the generated crack propagates or not. TCD will provide an additional powerful tool to the existing crack initiation fatigue life prediction technique in fatigue analysis.						
PEARL 1:15-4:30	Manufacturing Process Simulation	Multiphysics Manufacturing Process Simulation: Modern manufacturing processes are complex, with even minor variances capable of leading to significant challenges, costly delays, and excessive scrap. This seminar will showcase various workflows for simulating manufacturing across three key industries: Transportation & Mobility, Aerospace & Defense, and High-Tech Semiconductors.  In Transportation & Mobility, we will present simulation techniques for metal processes such as forming, deep drawing, rolling, and welding, demonstrating how these can enhance efficiency and quality control. For Aerospace & Defense, the seminar will cover advanced simulations for composite processes, including molding, forming, braiding, and curing, ensuring innovation while meeting strict safety standards.  Semiconductor manufacturing process is complex and capital-intensive, requiring high precision, efficiency, and adaptability at every stage. From wafer fabrication and photolithography to etching, deposition, chemical mechanical planarization (CMP), solder reflow, underfill filling, underfill curing, thermal interface material phase change in packages etc., each step presents unique challenges. Dassault Systèmes Multiphysics-Multiscale framework provides advanced simulation solutions tailored for this industry. This seminar will showcase cutting-edge simulation workflows for semiconductor manufacturing processes such as CMP, solder reflow, underfill material filling and curing, and wafer-to-wafer bonding for 3DHI.						
CORAL 9:00-12:15	Batteries	In this two-part seminar, we will present our advanced multiscale simulation technologies to systematically address and overcome these challenges in battery development:  • Session 1: The Molecular Scale: Driving Innovation in Li-Ion Battery Material Development with Material Simulation and Laboratory Informatics  • Session 2: The Engineering Scale: Diving Innovation in Li-Ion Battery Cell/Module/Pack Development with Multiphysics Simulation						



## **Conference Agenda**

## Day 2 | Wednesday, April 30, 2025

Register or learn more here

Day 2	Wednesday, April	30, 2025				Register or lear	n more <u>here</u>			
8:30 AM			Registration, Coffee & Breakfast	in Sponsor Exhibit Area and 3DEXPERIEN	CE Playground					
9:15 AM			Welcome & Opening Rem	narks: Shashank Aggarwal, Dassault	Systèmes					
9:30 AM			SIMULIA Brand Insigh	nts, Sebastien Gautier, Dassault Systo	èmes					
10:00 AM	Keynote Presentation: Wh	nat Side of V Flow Are You on? A Jou	rney from Simulating Performa	ance to Model-Based Decision Maki	<b>ng,</b> Charles Gagliano, Honda D	evelopment and Manufactu	ring of America, LLC			
10:30 AM			Morning Break in Sponso	or Exhibit Area and 3DEXPERIENCE Playg	round					
11:00 AM			MODSIM: The Importance of I	Being Unified, Ramji Kamakoti, Dass	ault Systèmes					
11:45 AM		The Critical	Role of the Analyst in the Evolution	on of FEA in Industry, Joe Formicola, G	oEngineer, Platinum Sponsor					
12:05 PM	Group Photo, Lunch, Sponsor Exhibit Area & Playground Open – Sponsored by VIAS3D									
	Track 1 – GOLD Sponsor Session	Track 2 – SILVER Sponsor Session	Track 3 – COPPER Sponsor Session							
1:20 PM	Firefighter Helmet of the Future! Combining Lattice Design and Simulation with 3DEXPERIENCE, Matthew Sherak & Steven Darcey, GoEngineer	Coupled Workflows for Thermomechanical and Oxidative Aging Analysis in Elastomers Will Mars, Endurica	Manage Multi-Disciplinary Load Cases in SDM: Model Setup and Evaluation of Results, Andreas Lohbrunner, SCALEsdm U.S.							
1:40 PM	Modeling and Simulation in the Age of Digital Transformation  Sumanth Kumar, VIAS3D	Accelerating the Speed and Clarity of Simulation/SIMULIA Results to Support Large-Scale Variation Analysis Prasad Mandava, VCollab	Accelerating SIMULIA Simulation Software Portfolio with NVIDIA GPUs and Lenovo ThinkSystem Servers, Ian Pegler & Kevin Dean, NVIDIA/Lenovo							
	Track 1 – GOLD Structures I: Transportation & Mobility	Track 2 – SILVER Structures II: Infrastructure, Energy & Materials	Track 3 – COPPER Multibody System Dynamics	Track 4 – BRONZE Modeling & Simulation	Track 5 – PEARL Electromagnetics	Track 6 – AMETHYST Fluids	Track 7 – CORAL Vibro-Acoustics			
2:00 PM	Simulation of Z-Folding Process in Prismatic Lithium-Ion Battery Assembly Using Abaqus Explicit Purushotham Kunduru, General Motors	A Case Study Integrating Analytical Calculations and Finite Element Analysis for Predictive Performance Assessment of Body Lock Ring Systems, Christopher Cookston, Baker Hughes	Body Structure Influence on Vehicle Handling Performance Hisham Sawan, Honda	Utilizing Engineering Templates to Assist in Detailed Pocket Design Kiera Rudden-Flanagan, Lockheed Martin	3M New Materials and Technologies for 5G/mmWave Era Jaewon Kim, 3M	Advancing the Aerospace and Energy Industries with PowerFLOW Matthew Langford, Techsburg	Validation of wave6 Model of Vehicle Audio System Across Full Audible Frequency Range Suresh Patra & Wenlong Yang, General Motors			
2:30 PM	Fatigue Strength Assessment of Injection-Molded Plastic Components for Electric Vehicles Sascha Pazour, PART Engineering, on behalf of Ascend	Fracture Mechanics Analysis Comparison Using Abaqus Progressive Damage and 3-D Crack Meshes of a Downhole Tool Greg Thorwald, Baker Hughes	Simpack Application in Driveline Control Integration Xing Xing, General Motors	Journey into Parametric Design Study for Aerospace Applications Marcus Lorenzo, Lockheed Martin	Modeling BCI EMC Tests in CST Matt Gee, Robert Bosch	A Correlation of Soiling between Road Test and PowerFLOW Analysis for a Camera Monitor System Wei He, Volvo Trucks	Adding Detail to Interior Windnoise Models using wave6 Together with PowerFLOW, Aaron Rinehimer & Chong Wang, General Motors			
3:00 PM			Afternoon Break in Spons	or Exhibit Area and 3DEXPERIENCE Playe	ground					
3:30 PM	Challenges of Modelling Fatigue in Magnesium Casting Alloys Yi Liu, General Motors	Accelerating Product Development of Gore High-Temperature Capacitors Using Abaqus CAE Venkateswaran Santhanam, W.L. Gore	MBD-FEM Co-Simulation Approach to Assess Strength of Automotive Chassis Components Fan Li, General Motors	Advancing Mold Design with Multiphysics Simulation and Automation on the 3DEXPERIENCE Platform Benjamin Beckelynck, Optimec	CST's TLM and Hybrid Solver Technology Help Tackle Electrically Large Problems, Yushi Tan, VIAS3D, on behalf of Antenna Research	Consistent Drag Prediction with CFD for a Vehicle with Bimodal Wake Cycling Pooyan Razi, General Motors	wave6 Simulation Aided Launch Vibration Mitigation of Lunar Trailblazer Spacecraft Indranil Dandaroy, Dassault Systèmes, on behalf of Eric Jacobs & Michael Reindl, Lockheed Martin			
	SIMULIA Updates 1	SIMULIA Updates II	SIMULIA Updates III	SIMULIA Updates IV	SIMULIA Updates V	SIMULIA Updates VI	SIMULIA Updates VII			
4:00 PM	Structures Abaqus – Introduction, CAE, Cloud, & HPC, Ross McLendon, Dassault Systèmes Abaqus Nonlinear Mechanics, Kingshuk	3DEXPERIENCE Process Automation and Design Exploration Update Christina Feist, Dassault Systèmes 3DEXPERIENCE Test Management	Multibody Systems Dynamics Simpack Update Motion Update Vinay Khemka and Binu Jose Kochucheruvil, Dassault	Leveraging Nonlinear Multiphysics MODSIM to Ensure Robust Designs Sri Paranjothy, Dassault Systèmes	<ul> <li>Electromagnetics</li> <li>Electromagnetics 2025</li> <li>Update</li> <li>AMCAD &amp; EOMYS: Two Recent Additions to the</li> </ul>	Aeroacoustic Simulations of a Commercial Air Handler System, Ryan Ferris, Dassault Systèmes on behalf of Gang Wang, Trane	Using wave6 and PowerFLOW to Predict Underbody Contributions to Vehicle Wind-Noise, Dassault Systèmes on behalf of Philippe Mordillat, Mehai Zerrad, Renault			
	Bose, Dassault Systèmes Abaqus Contact & Constraints, Harry Harkness, Dassault Systèmes	Introduction Raphael Bois, Dassault Systèmes	Systèmes	Streamlining Aerospace & Defense Model-Based Certification Through MODSIM Hunter Norrgard, Dassault Systèmes	SIMULIA Portfolio Frank Scharf & Tyler Dodge, Dassault Systèmes	Fluids Portfolio Kevin Carvalho & Justin Sacco, Dassault Systèmes	Vibro-Acoustics Phil Shorter, Dassault Systèmes			
5:00 PM		Even	ning Reception in Sponsor Exhibit Are	ea and 3DEXPERIENCE Playground – Spo	nsored by GoEngineer					



## **Conference Agenda**

Day 3 | Thursday, May 1, 2025

Register or learn more here

ay 5	Thursday, iviay	., 2023				Register or lea	m more <u>ner</u>		
9:15 AM	Registration, Coffee & Breakfast in Sponsor Exhibit Area and 3DEXPERIENCE Playground								
10:00 AM	Welcome & Opening Remarks: Shashank Aggarwal, Dassault Systèmes								
10:10 AM	Smarter Testing – Virtual + Real Hybrid Testing, Tony Goff, Dassault Systèmes								
10:40 AM	Keynote Presentation: Interfaces and Fractures in Advanced Microelectronics Packaging, Ganesh Subbarayan, Purdue University								
11:10 AM	SIMULIA Fluids: Advanced Simulation for Real-World Impact, Alain Belanger & Rick Shock, Dassault Systèmes								
11:40 AM	SIMULIA Executive Roundtable & Wrap-up, Shashank Aggarwal, Mark Bohm, Sebastien Gautier, Chris Whiting, Dassault Systèmes								
12:00 PM	Lunch in Sponsor Exhibit Area & 3DEXPERIENCE Playground Open								
	Track 1 – GOLD Structures I: Multi-Industry	Track 2 – SILVER Transportation & Mobility	Track 3 – COPPER Batteries	Track 4 – BRONZE Modeling & Simulation	Track 5 – PEARL Structures II: Industrial Equipment	Track 6 – AMETHYST Structures III: Life Sciences			
1:15 PM	Structural Validation of an Electric Drive Unit Inverter Cover and Correlation with Test Results Naresh Oza, Rivian Automotive	Optimized Notch Design to Minimize Electric Motor Cogging Noise Song He, General Motors	Simpack Continuous Integration Pipeline Hunter Poole, General Motors	Building a Material Library in the <b>3D</b> EXPERIENCE Material Calibration App James Swayze & Blake Hasselbring, Ford Motor Co.	Automating Pre-Processing Tasks in Abaqus/CAE: A Python Solution for Faster Geometry Import and Meshing Jeevaratnam Myla, The Raymond Corporation	In Silico Tools for Prediction and Rehabilitation of Knee Osteoarthritis Amir Esrafilian, Stanford University			
1:45 PM	Translating Material Properties from Third-Party Explicit/FEA Codes to Abaqus/Explicit Chunfu Lin, General Motors	NVH Simulator Simpack Real- Time Functionality Development Xing Xing, General Motors	Coupled Thermal Electric Simulation of an Orthotropic Equivalent Battery Management System Martin Bridge, Navitas Systems	Considering Buckling in Topology Optimization for Aerospace Applications Jason Action & Clay McElwain, Lockheed Martin	Design Evaluation of Vehicle Cab Floor Under Extreme Loads using Advanced Simulations Akshay Dandekar & Arindam Chakraborty, VIAS3D, presenting on behalf of Motiv	Developing of an Organ- and Tissue-Level Calibrated Human Lung Model: Preliminary Findings & Future Directions Arif Badrou, University of California			
2:15 PM	Accelerating Composite Material Design through Integration of Large Language Models with Multiscale Mechanics Haodong Du, Purdue University	Study & Recommendation for Simpack use on a VI-grade Autohawk Real-Time Linux High- Power Computer John Burford & Mollie Minsel, VI-grade	Design of Electric Single-Seater Type Electrathon America Vignaud Granados Alejo, Alejandra Guzman & Frollan Marguez, Universidad Politecnica de Guanajuato	OPTIMA: The Collaborative Development of OptiAssist Composite Optimization with Red Bull Advanced Technologies Martin Gambling, TriMech Solutions, on behalf of Red Bull		NiTiNol implementation and calibration in Abaqus/CAE and 3DEXPERIENCE Nuno Rebelo & Paul Jermihov, Nuno Rebelo Associates & Trimech			
	SIMULIA Updates I	SIMULIA Updates II	SIMULIA Updates III	SIMULIA Updates IV	SIMULIA Updates V	SIMULIA Updates VI			
2:45 PM	Structures Abaqus Linear Dynamics & Equation Solvers Mikhail Belyi, Dassault Systèmes	<b>3D</b> EXPERIENCE Structures, Adarsh Bavani Shankar, Dassault Systèmes	MODSIM Powered Concept Design and Democratized Workflow Anna Liang, Ashish Aggarwal & Balaji Ramanathan, Dassault Systèmes	<b>3D</b> EXPERIENCE Multiphysics 2025 Victor Oancea, Dassault Systèmes	Automotive Body Systems NVH Analysis John Huber, Dassault Systèmes	An Implementation of Digital Continuity Within Concept Structures with Systems Engineering Swati Umamaheshwaran, Dassault Systèmes			
3:30 PM		Constate Verse Con	vey for a Free Gift! See You Bo						